



# LG-03IR4C94C-302BA-B1 DATA SHEET

 SPEC. NO.
 :
 SZ20071701

 DATE
 :
 2020/07/17

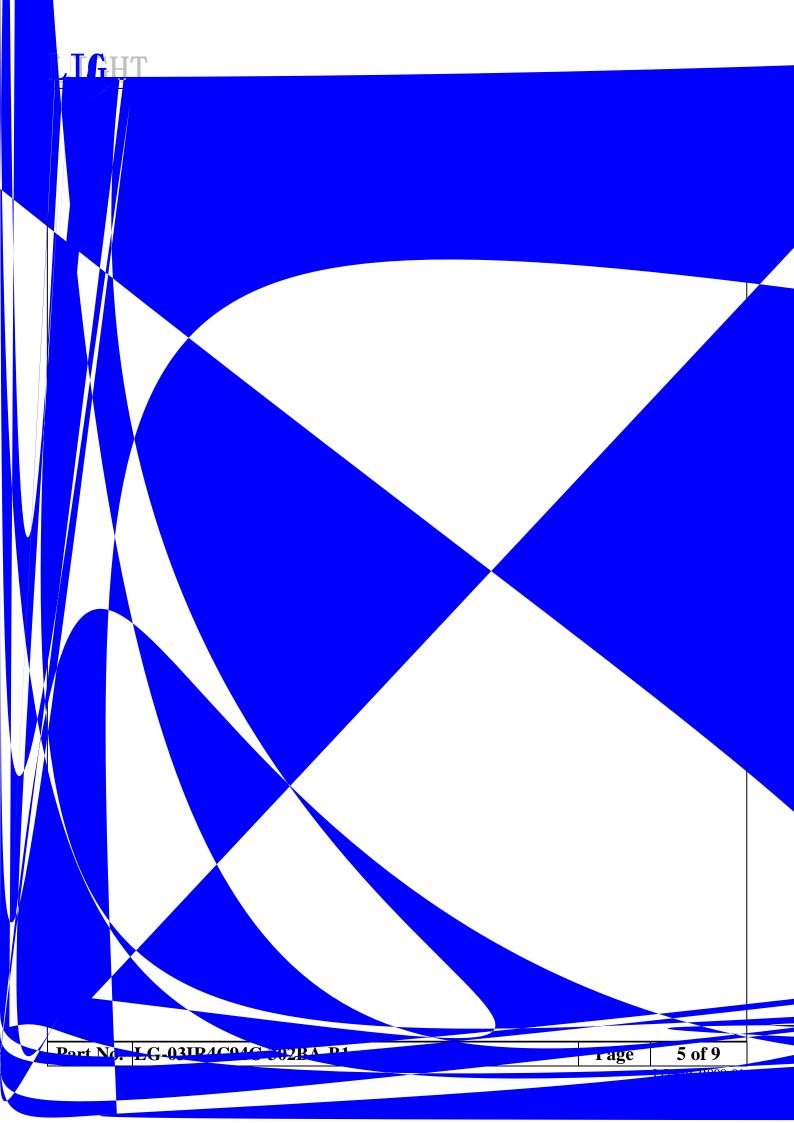
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Approved By:

Checked By:

Prepared By:

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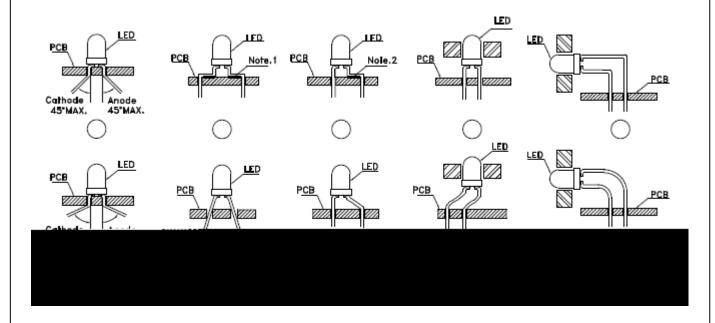


### LIGHT



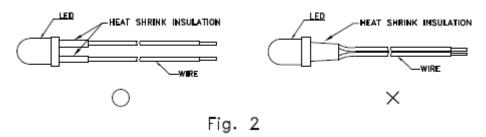
#### LED MOUNTING METHOD

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures (Fig.1).

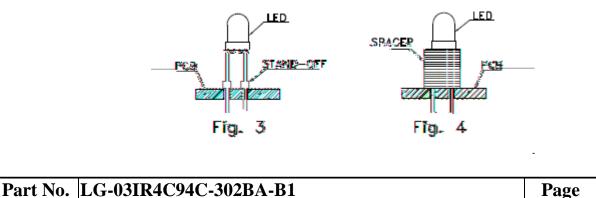


Note 1-2: Do not route PCB trace in the contact area between the lead frame and the PCB to prevent short-circuits.

2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit (Fig.2).



3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



### LIGH

## LIGHT



#### PACKAGE

